SN74ACT16373Q-EP **16-BIT D-TYPE TRANSPARENT LATCH** WITH 3-STATE OUTPUTS

48 11LE

47 1D1

46 1 1D2

45 GND

44] 1D3

43 1D4

42 VCC

41 1D5

40 1 1D6

39 GND

38 🛛 1D7

37 1 1D8

36 **2**D1

35 1 2D2

34 GND

33 2D3

32 2D4

31 VCC

30 2D5

29 2D6

28 GND 27 2D7

26 2D8

25 2LE

DL PACKAGE (TOP VIEW)

1OE

1Q1 🛛 2

1Q2 [3

GND 4

1Q3 5

1Q4 6

Vcc 7

1Q5 8

1Q6 🛛 9

GND 10

12

15

19

24

1Q7 🛛 11

1Q8 [

2Q1 🛛 13

2Q2 14

GND [

V_{CC} 18

2Q5

2Q3 16

2Q4 17

2Q6 🛛 20

GND 21

2Q7 222

2Q8 🛛 23

 $2\overline{OE}$

SCAS678B - MAY 2002 - REVISED JULY 2002

询"SN74ACT16373-FP"供应商

- **Controlled Baseline** - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of** -40°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- **Enhanced Product Change Notification**
- **Qualification Pedigree[†]**
- **Member of the Texas Instruments** Widebus[™] Family
- Inputs Are TTL-Voltage Compatible
- **3-State Bus Driving True Outputs**
- **Full Parallel Access for Loading**
- Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise

[†] Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, highly accelerated stress test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life.

description

The SN74ACT16373Q-EP is a 16-bit D-type transparent latch with 3-state outputs, designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

This device can be used as two 8-bit latches or one 16-bit latch. The Q outputs of the latches follow the data (D) inputs if the latch-enable (LE) input is taken high. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable (OE) input can be used to place the outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines in a bus-organized system, without need for interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered WWW.DZSC while the outputs are in the high-impedance state.



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SN74ACT16373Q-EP **16-BIT D-TYPE TRANSPARENT LATCH** WITH 3-STATE OUTPUTS

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ORDERING INFORMATION

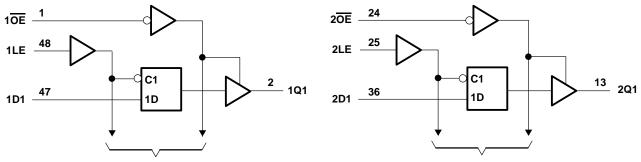
TA	PACKA	AGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	SSOP – DL	Tape and reel	SN74ACT16373QDLREP	ACT16373QEP

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	(eaci	i sectioi	1)
	INPUTS	OUTPUT	
OE	LE	D	Q
L	Н	Н	Н
L	н	L	L
L	L	Х	Q ₀
Н	Х	Х	Z

FUNCTION TABLE (analy contion)

logic diagram (positive logic)



To Seven Other Channels

To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC} Input voltage range, V _I (see Note 1)	
Output voltage range, V _O (see Note 1)	
Input clamp current, I _{IK} (V _I < 0 or V _I > V _{CC})	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±24 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±24 mA
Continuous current through V _{CC} or GND	
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DL package	1.2 W
Storage temperature range, T _{stg}	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.



SN74ACT16373Q-EP **16-BIT D-TYPE TRANSPARENT LATCH** WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
Vcc	Supply voltage (see Note 4)	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.8	V
VI	Input voltage	0	VCC	V
Vo	Output voltage	0	VCC	V
ЮН	High-level output current		-16	mA
IOL	Low-level output current		16	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
Т _А	Operating free-air temperature	-40	125	°C

NOTES: 3. Unused inputs should be tied to V_{CC} through a pullup resistor of approximately 5 kΩ or greater to prevent them from floating. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

4. All V_{CC} and GND pins must be connected to the proper-voltage power supply.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vee	Т	₄ = 25° Ω	;	MIN	МАХ	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX		WAA	
	I _{OH} = -50 μA	4.5 V	4.4			4.4		
	10H = -20 ftt	5.5 V	5.4			5.4		
VOH	I _{OH} = -16 mA	4.5 V	3.94			3.7		V
		5.5 V	4.94			4.7		
	$I_{OH} = -24 \text{ mA}^{\dagger}$	5.5 V				3.85		
	I _{OL} = 50 μA	4.5 V			0.1		0.1	V
	$OL = 50 \mu\text{A}$	5.5 V			0.1		0.1	
VOL	I _{OL} = 16 mA	4.5 V			0.36		0.5	
		5.5 V			0.36		0.5	
	$I_{OL} = 24 \text{ mA}^{\dagger}$	5.5 V					0.5	
lj	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μA
I _{OZ}	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±10	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		160	μA
∆I _{CC} ‡	One input at 3.4 V, Other inputs at GND or V_{CC}	5.5 V			0.9		1	mA
Ci	$V_{I} = V_{CC}$ or GND	5 V		4.5				pF
Co	$V_{I} = V_{CC}$ or GND	5 V		12				pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[±] This is the increase in supply current for each input that is at one of the specified TTL-voltage levels rather than 0 V to V_{CC}.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		T _A = 25	S°C	MIN	мах	UNIT
		MIN	MAX		IVIAA	UNIT
tw	Pulse duration, LE high	4		4		ns
t _{su}	Setup time, data before LE \downarrow	1		1		ns
th	Hold time, data after LE \downarrow	5		5		ns



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

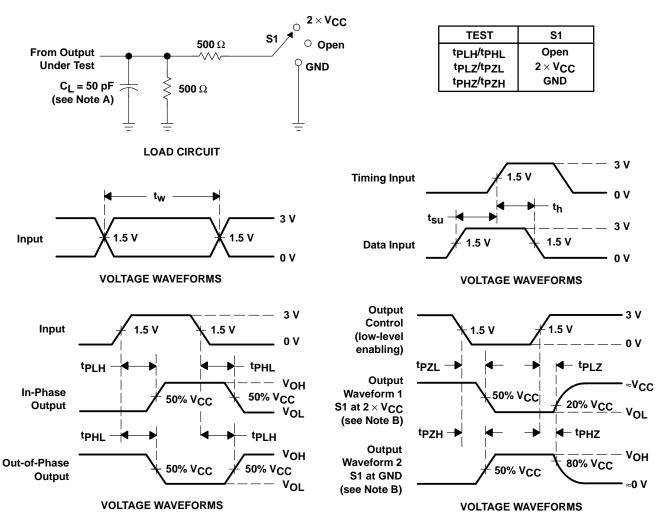
PARAMETER	FROM	то	Т	₄ = 25°C	;	MIN	МАХ	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX		WAA	UNIT
^t PLH	D	Q	3.8	7.9	9.4	3.8	11.8	200
^t PHL	D	Ŷ	3.1	8.2	9.7	3.1	13	ns
^t PLH	LE	Q	4.6	9.3	10.8	4.6	13.7	20
^t PHL	LL	Ŷ	4.5	9.1	10.5	4.5	13	ns
^t PZH	OE	Q	3.1	8	9.5	3.1	13	ns
^t PZL	ÛE	Ŷ	3.8	9.4	11.1	3.8	15.1	115
^t PHZ	OE	Q	5.3	8.6	9.9	5.3	11	ns
^t PLZ	UE	ý	4.3	7.4	8.7	4.3	9.8	115

operating characteristics, V_{CC} = 5 V, T_A = 25° C

	PARAMETER			TEST CONDITIONS		
C	. Dower dissinction conscitance per letab	Outputs enabled	C _I = 50 pF,	f = 1 MHz	43	рF
Cpo	C _{pd} Power dissipation capacitance per latch	Outputs disabled	CL = 50 pr,		4.5	рг



SN74ACT16373Q-EP 16-BIT D-TYPE TRANSPARENT LATCH WITH 3-STATE OUTPUTS SCAS678B – MAY 2002 – REVISED JULY 2002



PARAMETER MEASUREMENT INFORMATION

NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 3 ns, t_f = 3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



5-Feb-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins F	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ACT16373QDLREP	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/03602-01XE	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

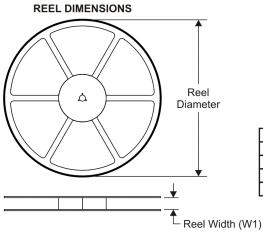
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

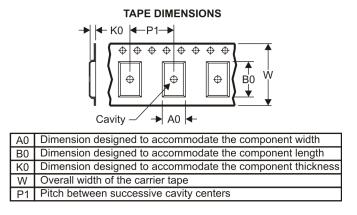
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	

Device		Package Drawing	Pins		Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ACT16373QDLREP	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



PACKAGE MATERIALS INFORMATION

5-Aug-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ACT16373QDLREP	SSOP	DL	48	1000	346.0	346.0	49.0

MECHANICAL DATA

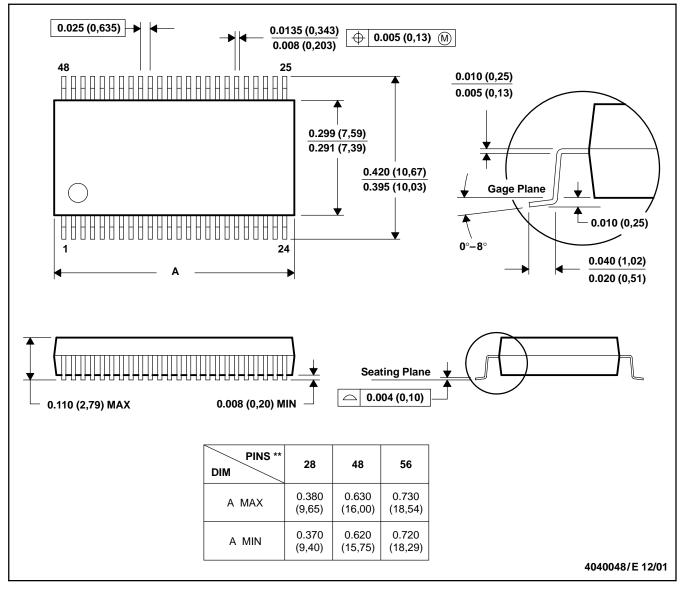
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MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

DL (R-PDSO-G**)

48 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118



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